APPROVAL SHEET

To:

Customer P/N:

UDE P/N: SA10-ZZ-0003

Description: SFP Cage 1X1

DIP

Without Lightpipe&heatsink

Packing With Hard Tray



Spec No. Update Date Revision SA1020003-00 2020/3/12 A

Approved	Checked	Prepared	



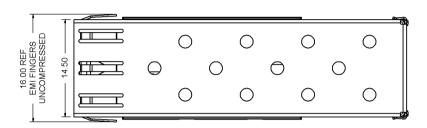
湧德電子 股份有限公司

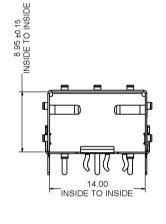
桃園市(33852) 蘆竹區內溪路 68 巷13號 No.13, Ln. 68, Neixi Rd., Luzhu Dist., Taoyuan City (33852), Taiwan TEL: 886-3-3242000 FAX: 886-3-3246611 http://www.ude-corp.com/

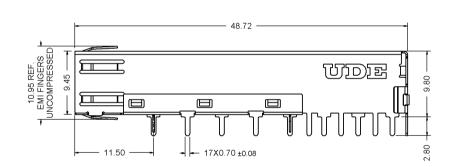
1. MECHANICAL DIMENSION

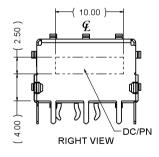
1.1 CAGE assembly Dimension

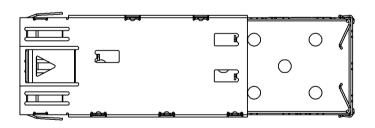
General Tolerance : $X.X : \pm 0.38$ $X.XX : \pm 0.20$







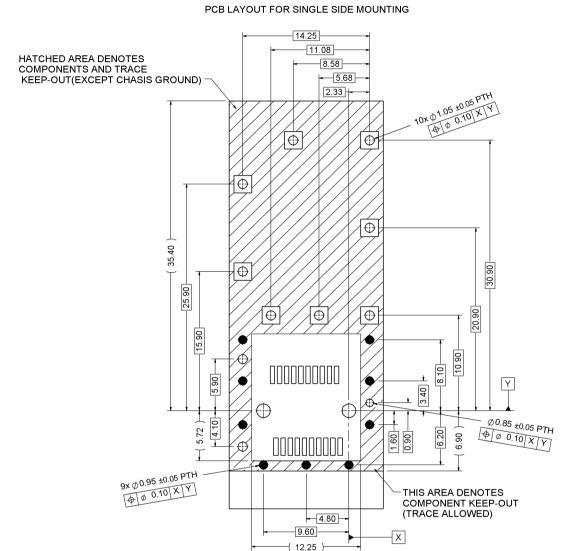




1.2 Recommended PCB Layout

Component Side of Board

All dimension tolerances are ± 0.05 mm unless otherwise specified



1.PADS AND VIAS CONNECT TO CHASSIS GROUND

RECOMMEND PADS TO BE 2.00mm SQUARE

2.RECOMMENDED THRU HOLE PLATING INCLUDES

HASL,OSP,OR IMMERSION(GOLD,SILVER,OR TIN)

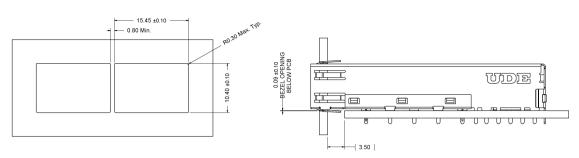
3.1.57mm MINIMUM PCB THICKNESS FOR SINGLE SIDED USE.

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1.3 Recommended Panel Cutout

PANELCUTOFF FOR SINGLE SIDE MOUNTING(SPRING FINGERS)



1.4 Packing Information

35 pcs finished goods per tray

9 trays(280 pcs finished goods) per master carton

2. REQUIREMENTS

2.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable.

2.2 Material

2.2.1 Shield Parts

2.2.1.1 Top Shell: Copper Alloy, Thickness=0.25mm

2.2.1.2 Bottom Shell: Copper Alloy, Thickness=0.25mm

2.3 Operating and Storage Temperature

Operating Temperature : -40 °C to +85 °C

Storage Temperature : -55 °C to +105 °C

2.4 SFP CAGE specifications

Insertion force: 18 N max at a max. rate of 25.4mm per minute

(SFP module to SFP cage)

Extraction force: 12.5 N max at a max. rate of 25.4mm per minute

(SFP module to SFP cage)

Cage Retention (Latch strength): 90N Min.

Durability: 100 cycles for standard class

2.5 Performance and Test Description

Product is designed to meet electrical, mechanical and environmental performance requirements specified in below table. All tests are performed at ambient environmental conditions per MIL-STD-1344A and EIA-364 unless otherwise specified.

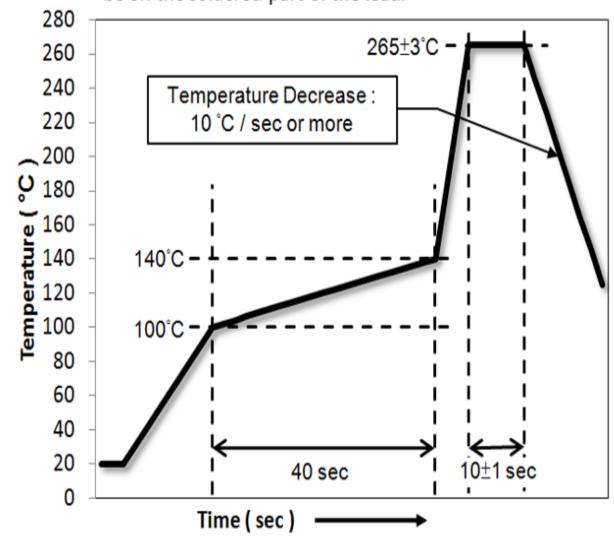
2.6 Packaging and Packing

All parts shall be packaged and packed to protect against physical damage, corrosion and deterioration during shipment and storage.



Note:

The measuring point for the specified temperature shall be on the soldered part of the lead.



3. Revision History				
Issue Date	Revision	Comments	Operator	
2020/3/12	A	Initial Release.	Jaye	